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Vishay Siliconix

# Automotive N-Channel 30 V (D-S) 175 °C MOSFET

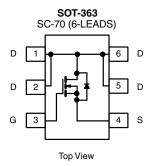
PRODUCT SUMMARY				
V <sub>DS</sub> (V)	30			
$R_{DS(on)}(\Omega)$ at $V_{GS} = 4.5 \text{ V}$	0.065			
$R_{DS(on)}(\Omega)$ at $V_{GS} = 2.5 \text{ V}$	0.095			
I <sub>D</sub> (A)	2.8			
Configuration	Single			

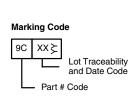
#### **FEATURES**

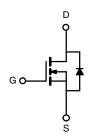
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- AEC-Q101 Qualified<sup>d</sup>
- 100 % Rq and UIS Tested
- Compliant to RoHS Directive 2002/95/EC











N-Channel MOSFET

ORDERING INFORMATION	
Package	SC-70
Lead (Pb)-free and Halogen-free	SQ1470EH-T1-GE3

<b>ABSOLUTE MAXIMUM RATING</b>	<b>S</b> ( $T_C = 25  ^{\circ}C$ , unless	s otherwise noted	d)		
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage		$V_{DS}$	30	V	
Gate-Source Voltage	V <sub>GS</sub>	± 12	V		
Continuous Drain Current <sup>a</sup>	T <sub>C</sub> = 25 °C		2.8	A	
	T <sub>C</sub> = 125 °C	I <sub>D</sub>	2.8		
Continuous Source Current (Diode Conducti	on) <sup>a</sup>	I <sub>S</sub>	2.8		
Pulsed Drain Current <sup>b</sup>		I <sub>DM</sub>	11		
Single Pulse Avalanche Current	1 04 ml	I <sub>AS</sub>	10		
Single Pulse Avalanche Energy	L = 0.1 mH	E <sub>AS</sub>	5	mJ	
Maximum Power Dissipation <sup>b</sup>	T <sub>C</sub> = 25 °C		3.3	W	
	T <sub>C</sub> = 125 °C	$P_{D}$	1.1		
Operating Junction and Storage Temperatur	e Range	T <sub>J</sub> , T <sub>stq</sub>	- 55 to + 175	°C	

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	LIMIT	UNIT		
Junction-to-Ambient	PCB Mount <sup>c</sup>	$R_{thJA}$	125	°C/W		
Junction-to-Foot (Drain)			45	C/VV		

#### **Notes**

- a. Package limited.
- b. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.
- c. When mounted on 1" square PCB (FR-4 material).
- d. Parametric verification ongoing.



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PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT		
Static	1			I.	·	ı		
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		30	-	-	V	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{DS} = V_{GS}, I_D = 250 \mu A$		1.0	1.6	V	
Gate-Source Leakage	I <sub>GSS</sub>	V <sub>DS</sub> =	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$		-	± 500	nA	
		V <sub>GS</sub> = 0 V	V <sub>DS</sub> = 30 V	=.	-	1		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>GS</sub> = 0 V	V <sub>DS</sub> = 30 V, T <sub>J</sub> = 125 °C	-	-	50	μΑ	
		V <sub>GS</sub> = 0 V	V <sub>DS</sub> = 30 V, T <sub>J</sub> = 175 °C	-	-	150		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>GS</sub> = 4.5 V	$V_{DS} \ge 5 V$	5	-	-	Α	
		V <sub>GS</sub> = 4.5 V	I <sub>D</sub> = 3.8 A	=.	0.050	0.065	Ω	
Drain Cauras On State Resistance	В	V <sub>GS</sub> = 4.5 V	I <sub>D</sub> = 3.8 A, T <sub>J</sub> = 125 °C	=.	-	0.097		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5 V	I <sub>D</sub> = 3.8 A, T <sub>J</sub> = 175 °C	-	-	0.115		
		V <sub>GS</sub> = 2.5 V	I <sub>D</sub> = 3.1 A	-	0.070	0.095		
Forward Transconductanceb	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 2 A		-	8	-	S	
Dynamic <sup>b</sup>								
Input Capacitance	C <sub>iss</sub>		V <sub>DS</sub> = 25 V, f = 1 MHz	-	488	610	pF	
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 V$		=.	60	75		
Reverse Transfer Capacitance	C <sub>rss</sub>	1		-	36	45		
Total Gate Charge <sup>c</sup>	Qg			-	4.4	6.6		
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	V <sub>GS</sub> = 4.5 V	$V_{DS} = 15 \text{ V}, I_{D} = 3.8 \text{ A}$	-	1	-	nC	
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>	1		-	1	-		
Gate Resistance	R <sub>g</sub>	f = 1 MHz		3	6.35	9.7	Ω	
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			-	8	12		
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD} = 15 \text{ V}, \text{ R}_{L} = 3.9 \Omega$ $I_{D} \cong 3.8 \text{ A}, \text{ V}_{GEN} = 4.5 \text{ V}, \text{ R}_{g} = 1 \Omega$		-	13	20	ns	
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>			-	14	21		
Fall Time <sup>c</sup>	t <sub>f</sub>			-	8	12		
Source-Drain Diode Ratings and Char-	acteristics <sup>b</sup>							
Pulsed Current <sup>a</sup>	I <sub>SM</sub>			-	-	11	Α	
Forward Voltage	V <sub>SD</sub>	I <sub>F</sub> =	-	0.8	1.2	V		

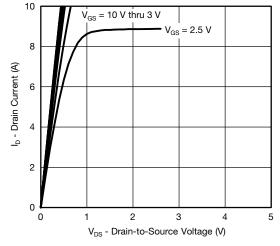
### Notes

- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %.
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

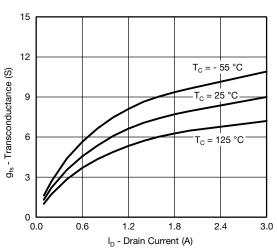
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



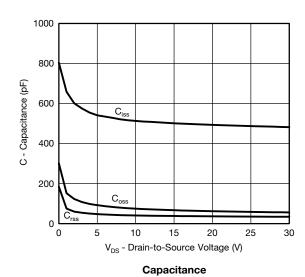
# TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

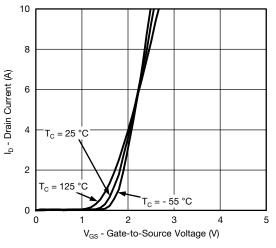


#### **Output Characteristics**

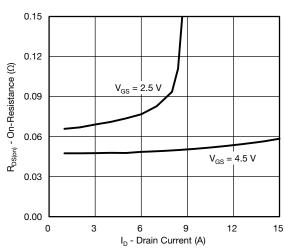


# Transconductance

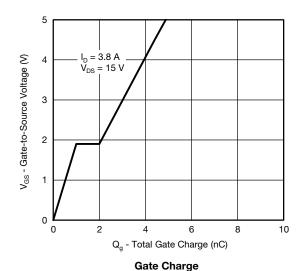




**Transfer Characteristics** 

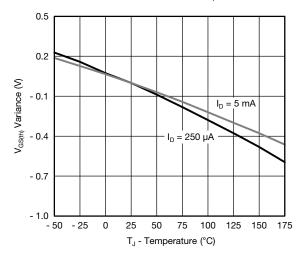


On-Resistance vs. Drain Current

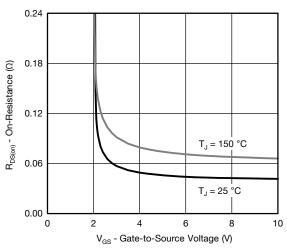




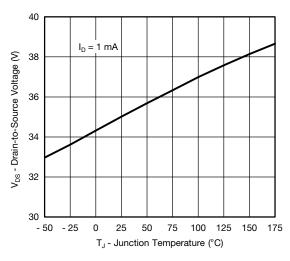
# TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



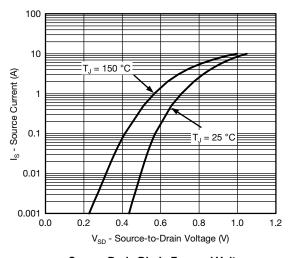
#### **Threshold Voltage**



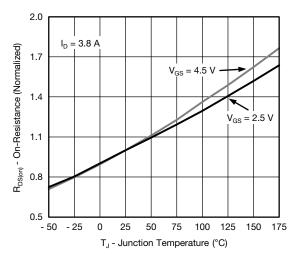
On-Resistance vs. Gate-to-Source Voltage



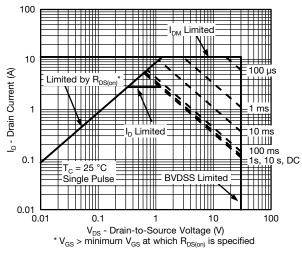
Drain Source Breakdown vs. Junction Temperature



### **Source Drain Diode Forward Voltage**

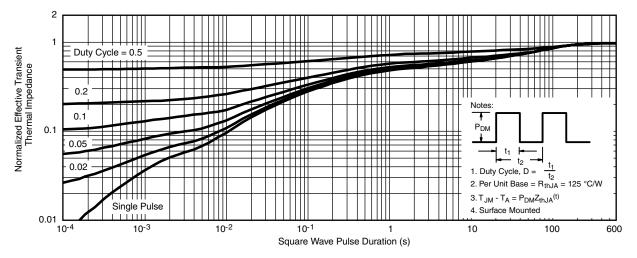


On-Resistance vs. Junction Temperature

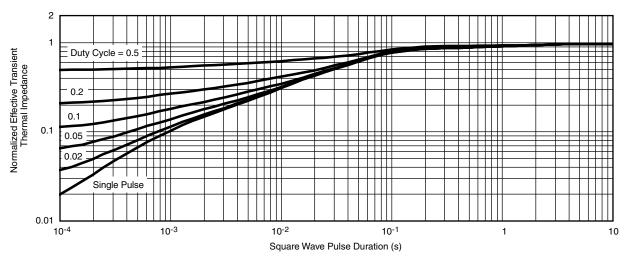




# THERMAL RATINGS (T<sub>A</sub> = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

#### Note

- The characteristics shown in the two graphs
  - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
  - Normalized Transient Thermal Impedance Junction-to-Foot (25 °C)

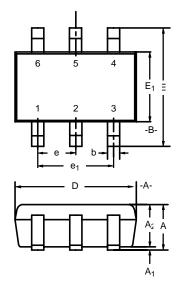
are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

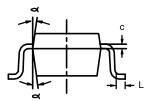
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg267059">www.vishay.com/ppg267059</a>.





## **SC-70: 6-LEADS**

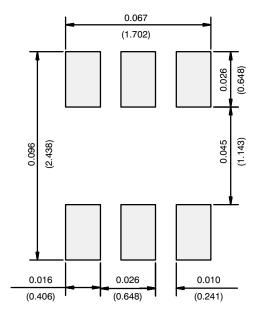




	MILLIMETERS			I	S	
Dim	Min	Nom	Max	Min	Nom	Max
Α	0.90	-	1.10	0.035	_	0.043
$A_1$	-	-	0.10	-	_	0.004
A <sub>2</sub>	0.80	-	1.00	0.031	_	0.039
b	0.15	-	0.30	0.006	_	0.012
С	0.10	-	0.25	0.004	-	0.010
D	1.80	2.00	2.20	0.071	0.079	0.087
Ε	1.80	2.10	2.40	0.071	0.083	0.094
E <sub>1</sub>	1.15	1.25	1.35	0.045	0.049	0.053
е	0.65BSC				0.026BSC	;
e <sub>1</sub>	1.20	1.30	1.40	0.047	0.051	0.055
L	0.10	0.20	0.30	0.004	0.008	0.012
ø	7°Nom				7°Nom	
ECN: S-03946—Rev. B, 09-Jul-01 DWG: 5550						



## **RECOMMENDED MINIMUM PADS FOR SC-70: 6-Lead**



Recommended Minimum Pads Dimensions in Inches/(mm)

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Revision: 02-Oct-12 Document Number: 91000